

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

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priority Application Serial No	08/984,730
priority Filing Date	
Inventor	
Assignee	
priority Group Art Unit	
priority Examiner	L. Wilson
Attorney's Docket No	
Title: Polishing Systems, Methods Of Polishing Substrates, and I	
Liquids For Semiconductor Fabrication Processes	

PRELIMINARY AMENDMENT

To: Assistant Commissioner for Patents

Washington, D.C. 20231

From: David G. Latwesen (Tel. 509-624-4276; Fax 509-838-3424)

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AMENDMENTS

In the Specification

At p. 1, before the "Technical Field" section, insert

-RELATED PATENT DATA

This patent resulted from a divisional application of U.S. Patent Application Serial No. 08/984,730, which was filed on December 4, 1997.

Amended Claims

Cancel claims 6-38.

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